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Vishay Semiconductors

GA400TD60S

Dual INT-A-PAK Low Profile "Half-Bridge" (Standard Speed IGBT), 400 A

600 V

750 A

1.24 V

Dual INT-A-PAK Low Profile

PRODUCT SUMMARY

VCES

 I_C DC at T_C = 25 °C

V_{CE(on)} (typical) at 400 A, 25 °C

FEATURES

- Generation 4 IGBT technology
- Standard: Optimized for hard switching speed DC to 1 kHz
 COMPLIANT
- Low V_{CE(on)}
- Square RBSOA
- HEXFRED[®] antiparallel diode with ultrasoft reverse recovery characteristics
- Industry standard package
- Al₂O₃ DBC
- UL approved file E78996
- Compliant to RoHS Directive 2002/95/EC
- Designed for industrial level

BENEFITS

- Increased operating efficiency
- Performance optimized as output inverter stage for TIG welding machines
- Direct mounting on heatsink
- Very low junction to case thermal resistance

ABSOLUTE MAXIMUM RATINGS					
PARAMETER	SYMBOL	TEST CONDITIONS	MAX.	UNITS	
Collector to emitter voltage	V _{CES}		600	V	
Continuous collector current	Ic ⁽¹⁾	$T_{\rm C} = 25 \ ^{\circ}{\rm C}$	750		
Continuous collector current	IC ("	$T_{\rm C} = 80 \ ^{\circ}{\rm C}$	525		
Pulsed collector current	I _{CM}		1000	А	
Clamped inductive load current	I _{LM}		1000	A	
Diode continuous forward current		T _C = 25 °C	219		
Didde continuous forward current	I _F	$T_{\rm C} = 80 \ ^{\circ}{\rm C}$	145		
Gate to emitter voltage	V _{GE}		± 20	V	
		T _C = 25 °C	1563	W	
Maximum power dissipation (IGBT)	PD	$T_{\rm C} = 80 \ ^{\circ}{\rm C}$	875	VV	
RMS isolation voltage	V _{ISOL}	Any terminal to case $(V_{RMS} t = 1 s, T_J = 25 °C)$	3500	V	

Note

⁽¹⁾ Maximum continuous collector current must be limited to 500 A to do not exceed the maximum temperature of terminals





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ELECTRICAL SPECIFICATIONS (T _J = 25 °C unless otherwise specified)							
PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNITS	
Collector to emitter breakdown voltage	V _{BR(CES)}	$V_{GE}=0~V,~I_C=500~\mu A$	600	-	-		
	V _{CE(on)}	$V_{GE} = 15 \text{ V}, \text{ I}_{C} = 300 \text{ A}$	-	1.14	1.35	- V	
Collector to emitter voltage		$V_{GE} = 15 \text{ V}, \text{ I}_{C} = 400 \text{ A}$	-	1.24	1.52		
		V_{GE} = 15 V, I_C = 300 A, T_J = 125 $^\circ C$	-	1.08	1.29		
		V_{GE} = 15 V, I_C = 400 A, T_J = 125 °C	-	1.21	1.5		
Gate threshold voltage	V _{GE(th)}	$V_{CE} = V_{GE}$, $I_C = 250 \ \mu A$	3.0	4.6	6.3		
	I _{CES}	$V_{GE} = 0 V, V_{CE} = 600 V$	-	0.075	1		
Collector to emitter leakage current		$V_{GE} = 0 \text{ V}, \text{ V}_{CE} = 600 \text{ V}, \text{ T}_{J} = 125 ^{\circ}\text{C}$	-	1.8	10	mA	
	V _{FM}	I _{FM} = 300 A	-	1.48	1.75	- V	
Diode forward voltage drop		I _{FM} = 400 A	-	1.63	1.98		
		I _{FM} = 300 A, T _J = 125 °C	-	1.50	1.77		
		I _{FM} = 400 A, T _J = 125 °C	-	1.70	2.04	1	
Gate to emitter leakage current	I _{GES}	$V_{GE} = \pm 20 \text{ V}$	-	-	± 200	nA	

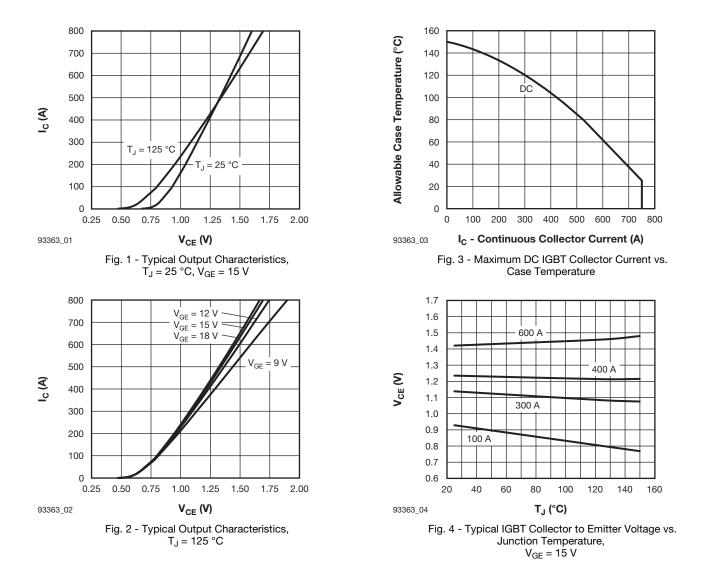
SWITCHING CHARACTERISTICS ($T_J = 25 \text{ °C}$ unless otherwise specified)							
PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNITS	
Turn-on switching loss	Eon		-	8.5	-		
Turn-off switching loss	E _{off}	I _C = 400 A, V _{CC} = 360 V, V _{GE} = 15 V, R _g = 1.5 Ω, L = 500 μH, T _J = 25 °C	-	113	-		
Total switching loss	E _{tot}		-	121.5	-		
Turn-on switching loss	Eon		-	21	-	mJ	
Turn-off switching loss	E _{off}		-	163	-	1	
Total switching loss	E _{tot}		-	184	-		
Turn-on delay time	t _{d(on)}	I _C = 400 A, V _{CC} = 360 V, V _{GE} = 15 V, R _g = 1.5 Ω, L = 500 μH, T _J = 125 °C	-	532	-		
Rise time	t _r		-	377	-		
Turn-off delay time	t _{d(off)}		-	496	-	ns	
Fall time	t _f		-	1303	-		
Reverse bias safe operating area	RBSOA	$ \begin{array}{l} T_J = 150 \ ^\circ C, \ I_C = 1000 \ A, \ V_{CC} = 400 \ V, \\ V_P = 600 \ V, \ R_g = 22 \ \Omega, \ V_{GE} = 15 \ V \ to \ 0 \ V, \\ L = 500 \ \mu H \end{array} $ Fullsquare					
Diode reverse recovery time	t _{rr}		-	150	179	ns	
Diode peak reverse current	I _{rr}	I _F = 300 A, dI _F /dt = 500 A/μs, V _{CC} = 400 V, T _J = 25 °C	-	43	59	А	
Diode recovery charge	Q _{rr}	, , , , , , , , , , , , , , , , , , ,	-	3.9	6.3	μC	
Diode reverse recovery time	t _{rr}		-	236	265	ns	
Diode peak reverse current	Irr	I _F = 300 A, dI _F /dt = 500 A/μs, V _{CC} = 400 V, T _J = 125 °C	-	64	80	А	
Diode recovery charge	Q _{rr}		-	8.6	11.1	μC	



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THERMAL AND MECHANICAL SPECIFICATIONS							
PARAMETER		SYMBOL	MIN.	TYP.	MAX.	UNITS	
Operating junction and storage temperature range		T _J , T _{Stg}	- 40	-	150	°C	
IGBT		D	-	-	0.08		
Junction to case per leg —	Diode	R _{thJC}	-	-	0.4	°C/W	
Case to sink per module		R _{thCS}	-	0.05	-		
Manuation to your	case to heatsink: M6 screw		4	-	6	Nim	
Mounting torque — ca	ase to terminal 1, 2, 3: M5 screw		2	-	4	Nm	
Weight			-	270	-	g	





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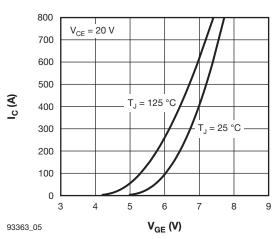
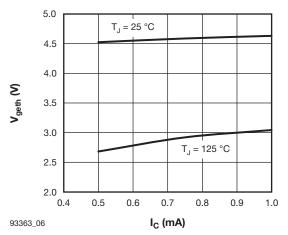
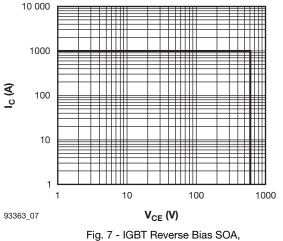
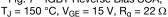


Fig. 5 - Typical IGBT Transfer Characteristics









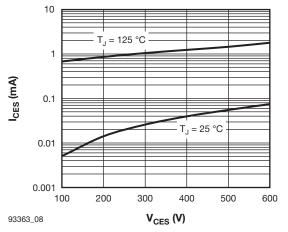
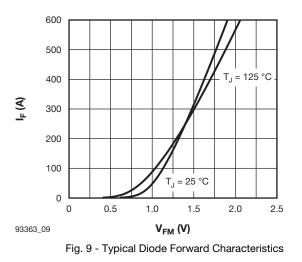
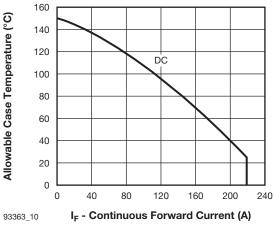
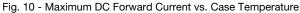


Fig. 8 - Typical IGBT Zero Gate Voltage Collector Current







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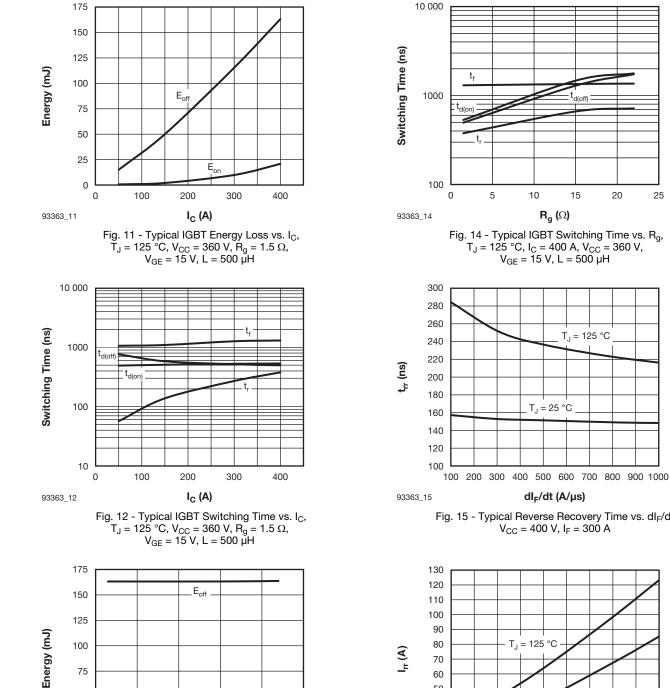
Dual INT-A-PAK Low Profile "Half-Bridge" Vishay Semiconductors (Standard Speed IGBT), 400 A

15

T_J = 125 °C

R_g (Ω)

20



dl_F/dt (A/µs) Fig. 15 - Typical Reverse Recovery Time vs. $dI_{\text{F}}/dt,$ $V_{CC} = 400 \text{ V}, I_F = 300 \text{ A}$ T_{.1} = 125 °C I_{rr} (A) 70 60 50 40 = 25 °C T_{.1} 30 20 10 100 200 300 400 500 600 700 800 900 1000 dl_r/dt (A/µs) 93363_16 Fig. 16 - Typical Reverse Recovery Current vs. dI_F/dt, $V_{CC} = 400 \text{ V}, I_F = 300 \text{ A}$

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75

50

25

0

93363_13

0

E_{on}

R_g (Ω)

Fig. 13 - Typical IGBT Energy Loss vs. Rg,

 $T_J = 125 \text{ °C}, I_C = 400 \text{ A}, V_{CC} = 360 \text{ V}, V_{GE} = 15 \text{ V}, L = 500 \,\mu\text{H}$

15

20

25

10

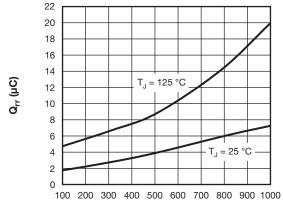
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For technical questions, contact: indmodules@vishay.com

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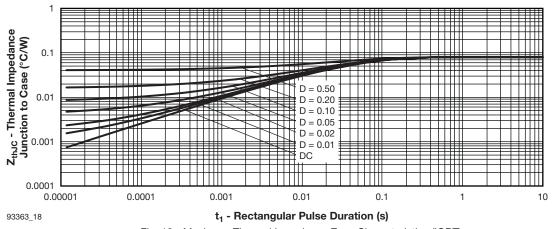




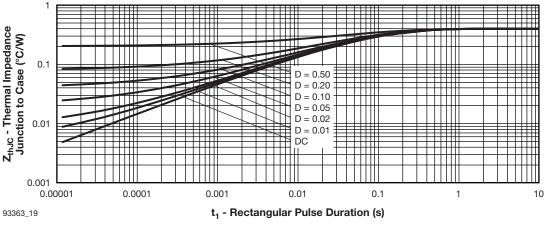
dl_F/dt (A/µs)

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Fig. 17 - Typical Reverse Recovery Charge vs. dl_F/dt, $V_{CC} = 400 \text{ V}, I_F = 300 \text{ A}$









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ORDERING INFORMATION TABLE

Device code

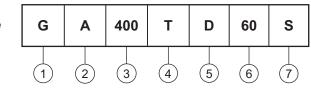
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4

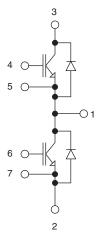
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Insulated Gate Bipolar Transistor (IGBT)

- A = Generation 4 IGBT
- Current rating (400 = 400 A)
- Circuit configuration (T = Half-bridge)
- Package indicator (D = Dual INT-A-PAK Low Profile)
- 6 Voltage rating (60 = 600 V)
- 7 Speed/type (S = Standard Speed IGBT)

CIRCUIT CONFIGURATION



LINKS TO RELATED DOCUMENTS				
Dimensions	www.vishay.com/doc?95435			



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